

Atty Docket No. JCLA12969

Serial No. 10/786,703

**In The Claims:**

1. (Currently Amended) A transistor comprising:

a P-substrate;

a first diffusion region and a second diffusion region formed in said P-substrate; wherein said first diffusion region and said second diffusion containing N conductivity-type ions form an N-well in said P-substrate; wherein said first diffusion region comprises an extended drain region;

a drain diffusion region containing N+ conductivity-type ions, forming a drain region in said extended drain region;

a third diffusion region containing P conductivity-type ions, comprising a P-field and divided P-fields formed in said extended drain region; wherein said divided P-fields are located nearer to said drain region compared to said P-field, and wherein said P-field and said divided P-fields generate junction fields;

~~a source diffusion region having N+ conductivity type ions, forming a source region in said N-well formed by said second diffusion region;~~

~~a channel, formed between said source region and said drain region;~~

~~a polysilicon gate electrode, formed over said channel to control a current flow in said channel;~~

~~a contact diffusion region containing P+ conductivity type ions, forming a contact region in said N-well formed by said second diffusion region; and~~

~~a fourth diffusion region containing P conductivity type ions, forming an isolated P well in~~

Atty Docket No. JCLA12969

Serial No. 10/786,703

~~said N-well formed by said second diffusion region for preventing from breakdown, wherein said isolated P-well encloses said source region and said contact region.~~

a fourth diffusion region containing P conductivity-type ions, forming an isolated P-well in said N-well formed by said second diffusion region for preventing from breakdown, wherein a left edge of the first diffusion region touches a right edge of the second diffusion region.

a source diffusion region having N+ conductivity-type ions, forming a source region in said P-well formed in said second diffusion region;

a channel, formed between said source region and said drain region;

a polysilicon gate electrode, formed over said channel to control a current flow in said channel; and

a contact diffusion region containing P+ conductivity-type ions, forming a contact region in said P-well formed in said second diffusion region.

2. (Original) The transistor of claim 1, wherein said N-well formed by said second diffusion region provides a low-impedance path for said source region and restricts a transistor current flow in between said drain region and said source region.

3. (Original) The transistor of claim 1, further comprising:

a thin gate oxide layer, formed over said channel;

a thick field oxide, formed laterally adjacent to said thin gate oxide layer;

a drain-gap, formed between said drain diffusion region and said thick field oxide to maintain a space between said drain diffusion region and said thick field oxide;

a source-gap, formed between said thick field oxide and said isolated P-well to maintain a

Atty Docket No. JCLA12969

Serial No. 10/786,703

space between said thick field oxide and said isolated P-well;

an insulation layer, covering said polysilicon gate electrode and said thick field oxide;

a drain metal contact, having a first metal electrode for contacting with said drain diffusion region; and

a source metal contact, having a second metal electrode for contacting with said source diffusion region and said contact diffusion region.

4. (Currently Amended) The transistor of claim ~~[[1]]~~ 3, further comprising:

a drain bonding pad, for connecting to said drain metal contact for a drain electrode;

a source bonding pad, for connecting to said source metal contact for a source electrode;

and

a gate bonding pad, for connecting to said polysilicon gate electrode.

5. (Original) The transistor of claim 1, wherein said P-field and said divided P-fields form junction-fields in said N-well to deplete a drift region.

Atty Docket No. JCLA12969

Serial No. 10/786,703

THIS PAGE BLANK (USPTO)